

## 30V N-Channel Enhancement Mode MOSFET

### Description

The AP6N03SI uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a Battery protection or in other Switching application.

### General Features

$V_{DS} = 30V$   $I_D = 6.3A$

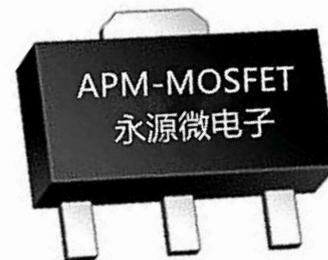
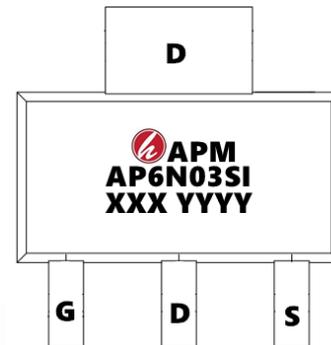
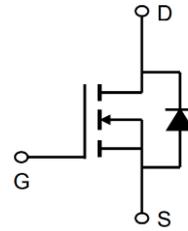
$R_{DS(ON)} < 35m\Omega$  @  $V_{GS}=4.5V$  (Type: **24mΩ**)

### Application

3.3V MCU

Load switch

Uninterruptible power supply



### Package Marking and Ordering Information

| Product ID | Pack     | Marking           | Qty(PCS) |
|------------|----------|-------------------|----------|
| AP6N03SI   | SOT89-3L | AP6N03SI XXX YYYY | 3000     |

### Absolute Maximum Ratings ( $T_C=25^\circ\text{C}$ unless otherwise noted)

| Symbol                     | Parameter   | Rating     | Units              |
|----------------------------|---|------------|--------------------|
| $V_{DS}$                   | Drain-Source Voltage  | 30         | V                  |
| $V_{GS}$                   | Gate-Source Voltage   | $\pm 12$   | V                  |
| $I_D@T_A=25^\circ\text{C}$ | Continuous Drain Current  | 6.3        | A                  |
| $I_D@T_A=70^\circ\text{C}$ | Continuous Drain Current  | 4.7        | A                  |
| $I_{DM}$                   | Pulsed Drain Current <sup>2</sup>                                 | 30         | A                  |
| $P_D@T_A=25^\circ\text{C}$ | Total Power Dissipation <sup>3</sup>                              | 1.5        | W                  |
| $T_{STG}$                  | Storage Temperature Range   | -55 to 150 | $^\circ\text{C}$   |
| $T_J$                      | Operating Junction Temperature Range                              | -55 to 150 | $^\circ\text{C}$   |
| $R_{\theta JA}$            | Thermal Resistance Junction-ambient <sup>1</sup>                  | 85         | $^\circ\text{C/W}$ |
| $R_{\theta JA}$            | Thermal Resistance Junction-Ambient <sup>1</sup> ( $t \leq 10s$ ) | 30         | $^\circ\text{C/W}$ |

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### Electrical Characteristics ( $T_J=25^\circ\text{C}$ , unless otherwise noted)

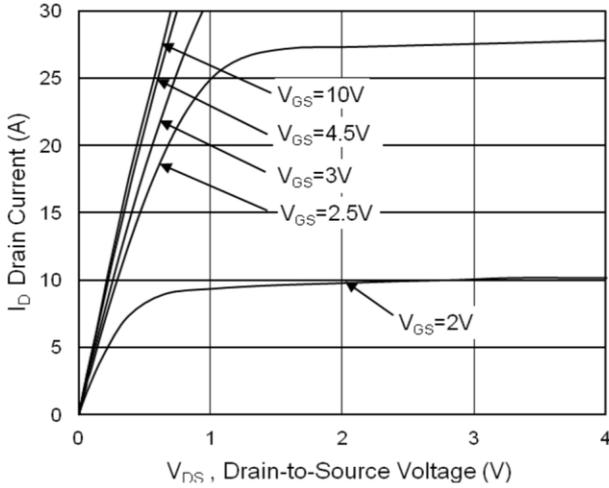
| Symbol                    | Parameter                                      | Conditions   | Min. | Typ.  | Max.      | Unit                       |
|---------------------------|--|--|------|-------|-----------|----------------------------|
| BVDSS                     | Drain-Source Breakdown Voltage                 | $V_{GS}=0V, I_D=250\mu A$                          | 30   | 33    | ---       | V                          |
| $\Delta BVDSS/\Delta T_J$ | BVDSS Temperature Coefficient                  | Reference to $25^\circ\text{C}$ , $I_D=1\text{mA}$ | ---  | 0.029 | ---       | $V/^\circ\text{C}$         |
| RDS(ON)                   | Static Drain-Source On-Resistance <sup>2</sup> | $V_{GS}=10V, I_D=5A$                               | ---  | 22    | 26        | m $\Omega$                 |
|                           |  | $V_{GS}=4.5V, I_D=3A$                              | ---  | 24    | 35        |                            |
|                           |  | $V_{GS}=2.5V, I_D=1A$                              | ---  | 36    | 40        |                            |
| VGS(th)                   | Gate Threshold Voltage                         | $V_{GS}=V_{DS}, I_D=250\mu A$                      | 0.5  | 0.9   | 1.2       | V                          |
| $\Delta V_{GS(th)}$       | $V_{GS(th)}$ Temperature Coefficient           |  | ---  | -2.82 | ---       | $\text{mV}/^\circ\text{C}$ |
| IDSS                      | Drain-Source Leakage Current                   | $V_{DS}=24V, V_{GS}=0V, T_J=25^\circ\text{C}$      | ---  | ---   | 1         | $\mu\text{A}$              |
|                           |  | $V_{DS}=24V, V_{GS}=0V, T_J=55^\circ\text{C}$      | ---  | ---   | 5         |                            |
| IGSS                      | Gate-Source Leakage Current                    | $V_{GS}=\pm 12V, V_{DS}=0V$                        | ---  | ---   | $\pm 100$ | nA                         |
| gfs                       | Forward Transconductance                       | $V_{DS}=5V, I_D=5A$                                | ---  | 25    | ---       | S                          |
| Rg                        | Gate Resistance                                | $V_{DS}=0V, V_{GS}=0V, f=1\text{MHz}$              | ---  | 1.5   | ---       | $\Omega$                   |
| Qg                        | Total Gate Charge (4.5V)                       | $V_{DS}=15V, V_{GS}=4.5V, I_D=5.8A$                | ---  | 11.5  | ---       | nC                         |
| Qgs                       | Gate-Source Charge                             |  | ---  | 1.6   | ---       |                            |
| Qgd                       | Gate-Drain Charge                              |  | ---  | 2.9   | ---       |                            |
| Td(on)                    | Turn-On Delay Time                             | $V_{DD}=15V, V_{GS}=10V, R_G=3\Omega$<br>$I_D=5A$  | ---  | 5     | ---       | ns                         |
| Tr                        | Rise Time                                      |  | ---  | 47.   | ---       |                            |
| Td(off)                   | Turn-Off Delay Time                            |  | ---  | 26    | ---       |                            |
| Tf                        | Fall Time                                      |  | ---  | 8     | ---       |                            |
| Ciss                      | Input Capacitance                              | $V_{DS}=15V, V_{GS}=0V, f=1\text{MHz}$             | ---  | 530   | ---       | pF                         |
| Coss                      | Output Capacitance                             |  | ---  | 130   | ---       |                            |
| Crss                      | Reverse Transfer Capacitance                   |  | ---  | 36    | ---       |                            |
| Is                        | Continuous Source Current <sup>1,4</sup>       | $V_G=V_D=0V, \text{Force Current}$                 | ---  | ---   | 5.8       | A                          |
| VSD                       | Diode Forward Voltage <sup>2</sup>             | $V_{GS}=0V, I_S=1A, T_J=25^\circ\text{C}$          | ---  | ---   | 1.2       | V                          |

#### Note :

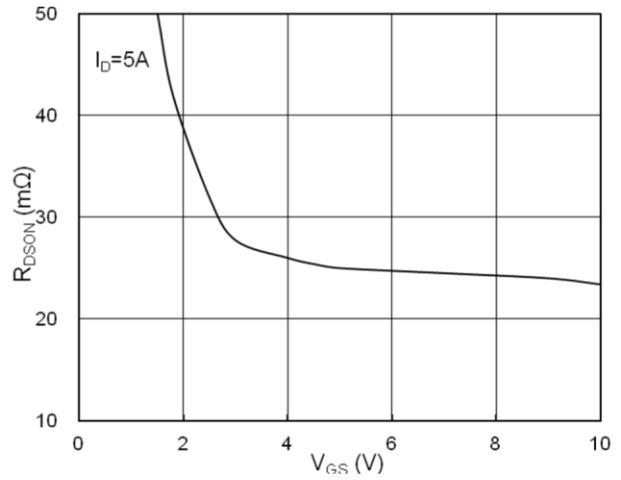
- 1、The data tested by surface mounted on a 1 inch<sup>2</sup> FR-4 board with 2OZ copper.
- 2、The data tested by pulsed , pulse width  $\leq 300\mu\text{s}$  , duty cycle  $\leq 2\%$
- 3、The power dissipation is limited by  $150^\circ\text{C}$  junction temperature
- 4、The data is theoretically the same as  $I_D$  and  $I_{DM}$  , in real applications , should be limited by total power dissipation.

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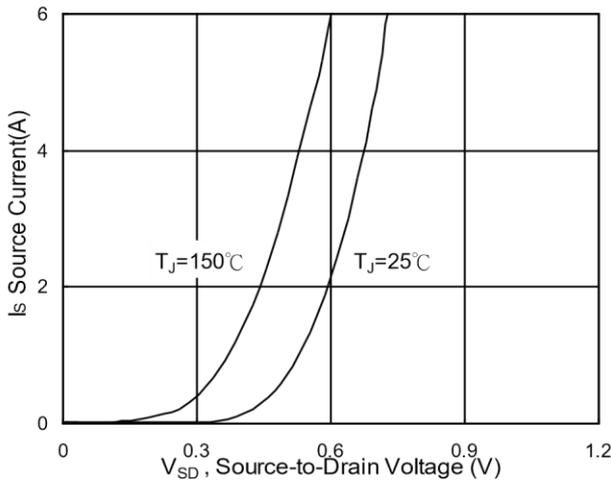
**Typical Characteristics**



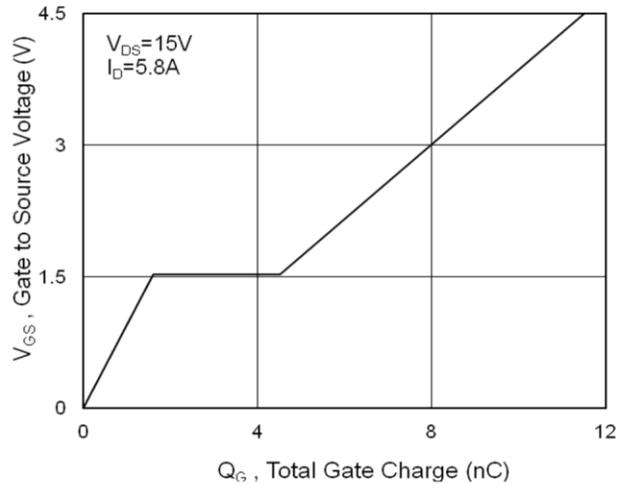
**Fig.1 Typical Output Characteristics**



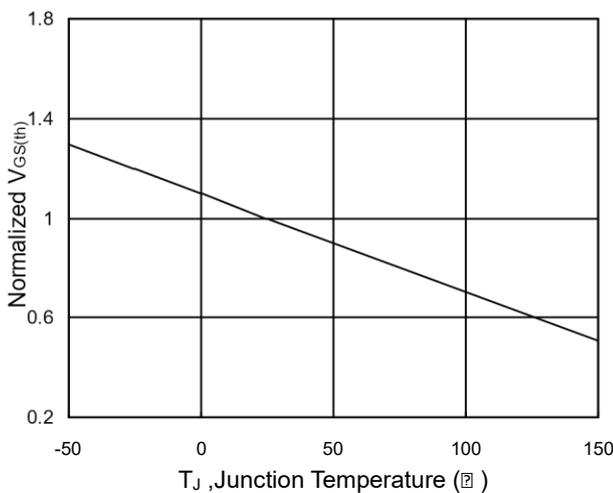
**Fig.2 On-Resistance vs. Gate-Source**



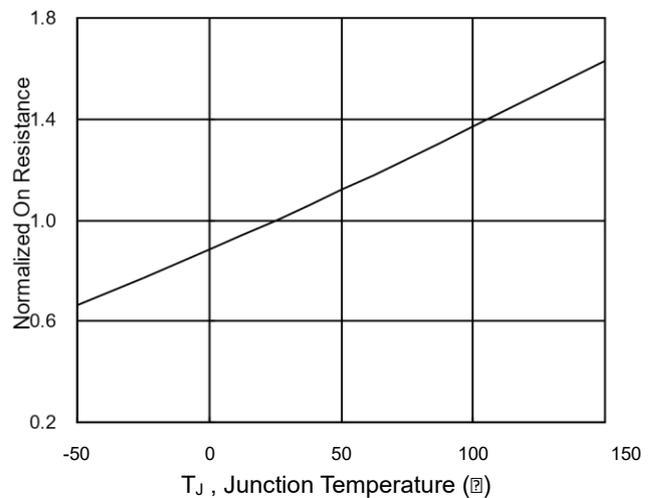
**Fig.3 Forward Characteristics Of Reverse**



**Fig.4 Gate-Charge Characteristics**



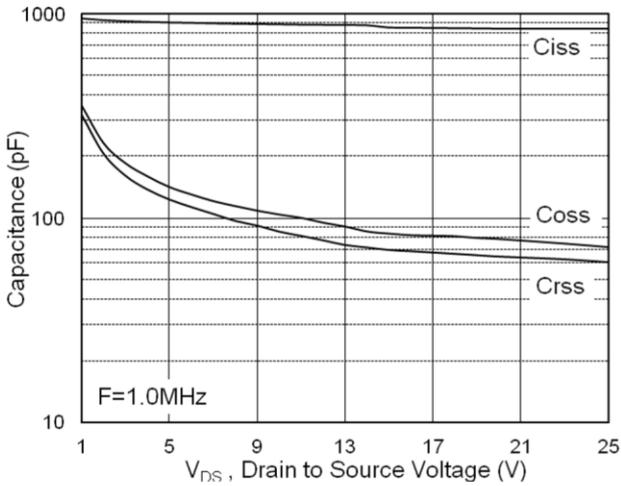
**Fig.5 Normalized  $V_{GS(th)}$  vs.  $T_J$**



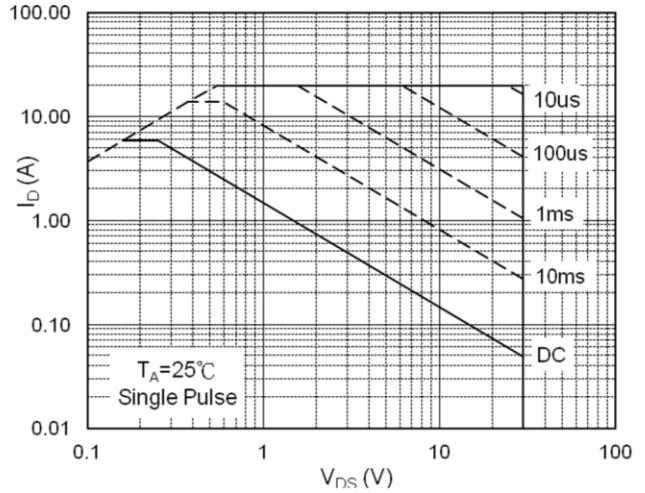
**Fig.6 Normalized  $R_{DS(on)}$  vs.  $T_J$**



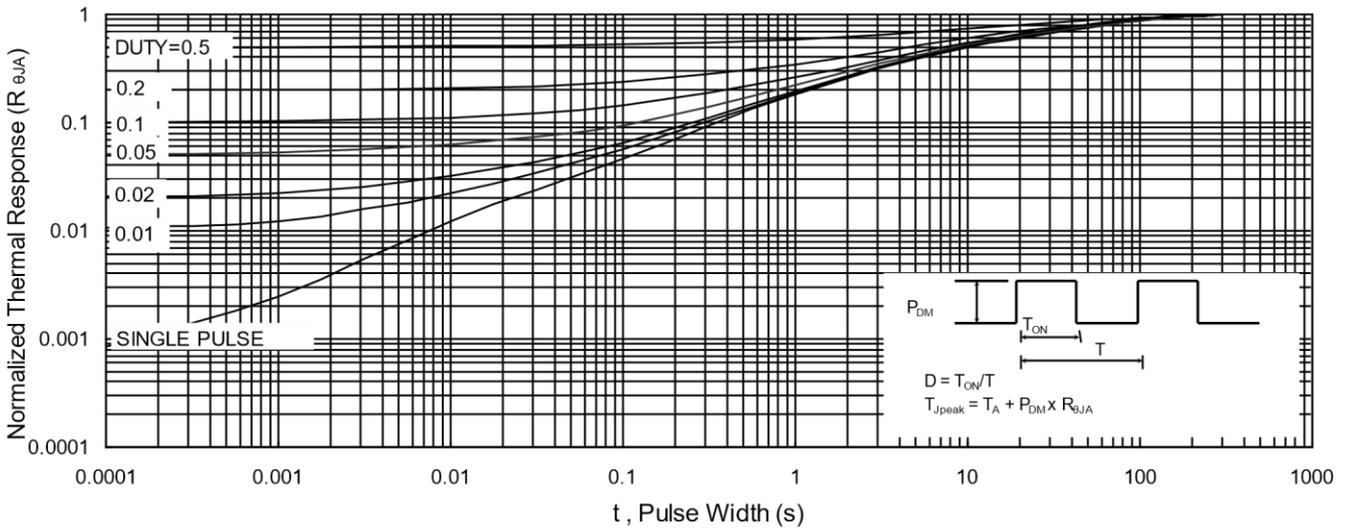
**30V N-Channel Enhancement Mode MOSFET**



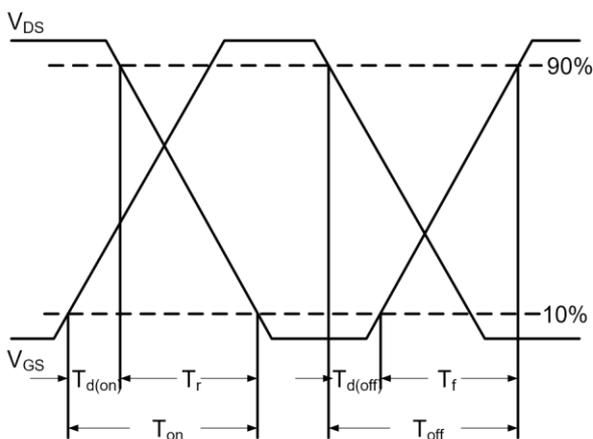
**Fig.7 Capacitance**



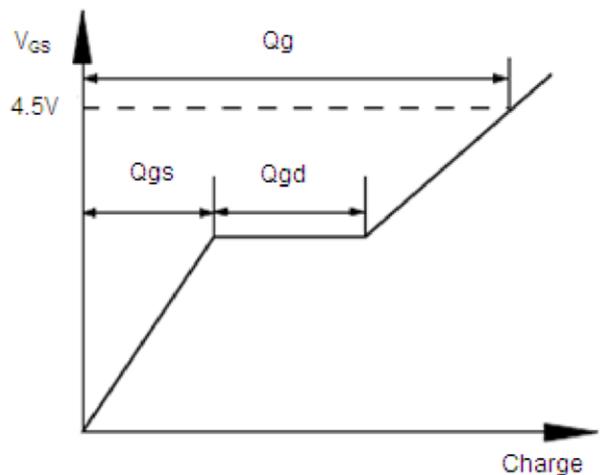
**Fig.8 Safe Operating Area**



**Fig.9 Normalized Maximum Transient Thermal Impedance**

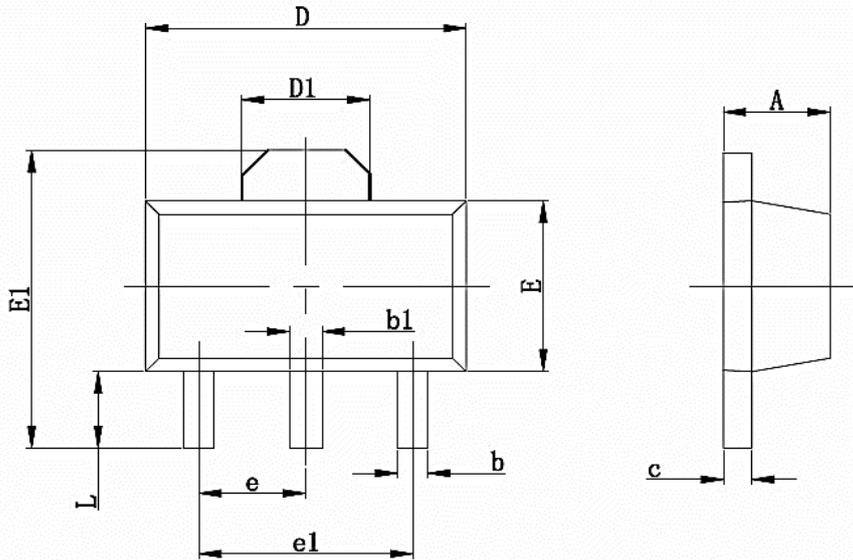


**Fig.10 Switching Time Waveform**



**Fig.11 Gate Charge Waveform**

**Package Mechanical Data:SOT89-3L**



| Symbol | Dimensions In Millimeters |       | Dimensions In Inches |       |
|--------|---------------------------|-------|----------------------|-------|
|        | Min                       | Max   | Min                  | Max   |
| A      | 1.400                     | 1.600 | 0.055                | 0.063 |
| b      | 0.350                     | 0.520 | 0.013                | 0.197 |
| b1     | 0.400                     | 0.580 | 0.016                | 0.023 |
| c      | 0.350                     | 0.440 | 0.014                | 0.017 |
| D      | 4.400                     | 4.600 | 0.173                | 0.181 |
| D1     | 1.550 REF                 |       | 0.061 REF            |       |
| E      | 2.350                     | 2.550 | 0.091                | 0.102 |
| E1     | 3.940                     | 4.250 | 0.155                | 0.167 |
| e      | 1.500 TYP                 |       | 0.060TYP             |       |
| e1     | 3.000 TYP                 |       | 0.118TYP             |       |
| L      | 0.900                     | 1.100 | 0.035                | 0.047 |

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| <b>Edition</b> | <b>Date</b> | <b>Change</b>              |
|----------------|-------------|----------------------------|
| Rve3.0         | 2017/5/1    | Initial release            |
| Rve3.1         | 2020/5/20   | Change Marking TO AP6N03SI |

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